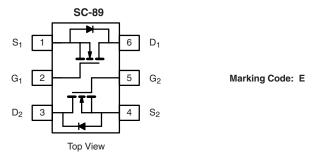


N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS(min)} (V)	R_{DS(on)} (Ω)	$V_{GS(th)}(V)$	I _D (mA)		
60	1.40 at V_{GS} = 10 V	1 to 2.5	500		



Ordering Information: Si1026X-T1-E3 (Lead (Pb)-free) Si1026X-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free Option Available
- Low On-Resistance: 1.40 Ω
- Low Threshold: 2 V (typ.)
- Low Input Capacitance: 30 pF
- Fast Switching Speed: 15 ns (typ.)
- Low Input and Output Leakage
- ESD Protected: 2000 V
- Miniature Package

BENEFITS

- Low Offset Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Error Voltage
- Small Board Area

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	60		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 25 °C	- I _D	320	305	
	T _A = 85 °C		230	220	
Pulsed Drain Current ^b		I _{DM}	- 650		mA
Continuous Source Current (Diode Conduction) ^a		۱ _S	450	380	
Maximum Power Dissipation ^a	T _A = 25 °C	- P _D	280	250	mW
	T _A = 85 °C		145	130	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000		V

Notes:

a. Surface Mounted on FR4 board.

b. Pulse width limited by maximum junction temperature.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{D} = 10 \mu A$	60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 0.25 \text{ mA}$	1		2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 10 V$			± 150	nA	
		$V_{DS} = 0 V, V_{GS} = \pm 5 V$			± 50		
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
	IDSS	V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 85 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	500			mA	
		$V_{DS} = 7.5 \text{ V}, V_{GS} = 10 \text{ V}$	800				
Drain-Source On-Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$			3.0	Ω	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 500 \text{ mA}$			1.40		
		V_{GS} = 10 V, I _D = 500 mA, T _J = 125 °C			2.50		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$		200		mS	
Diode Forward Voltage ^a	V_{SD}	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 200 \text{ mA}$			1.40	V	
Dynamic ^b							
Total Gate Charge	Qg			600		рС	
Gate-Source Charge	Q _{gs}	V_{DS} = 10 V, I _D = 250 mA, V _{GS} = 4.5 V		120			
Gate-Drain Charge	Q _{gd}			225			
Input Capacitance	C _{iss}	N 05 X X 0 X		30		pF	
Output Capacitance	C _{oss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz		6			
Reverse Transfer Capacitance	C _{rss}	1 - 1 101112		3			
Switching ^{b, c}							
Turn-On Time	t _(on)	V_{DD} = 30 V, R _L = 150 Ω I _D = 200 mA, V _{GEN} = 10 V, R _G = 10 Ω		15		ns	
Turn-Off Time	t _(off)			20			

Notes:

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

b. For DESIGN AID ONLY,, not subject to production testing.

c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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25 °C

125 °C

5

20

V_{GS} = 4.5 V

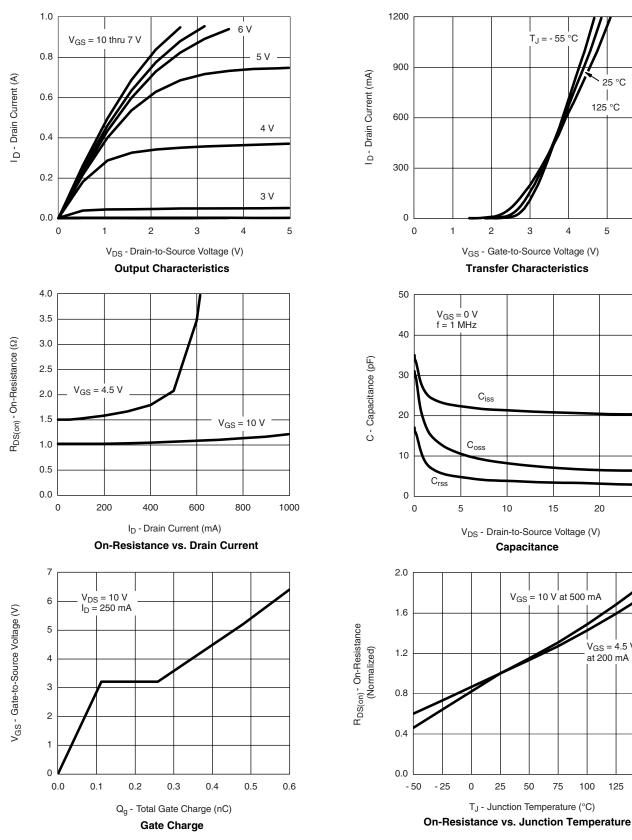
at 200 mA

25

6

4





125

150

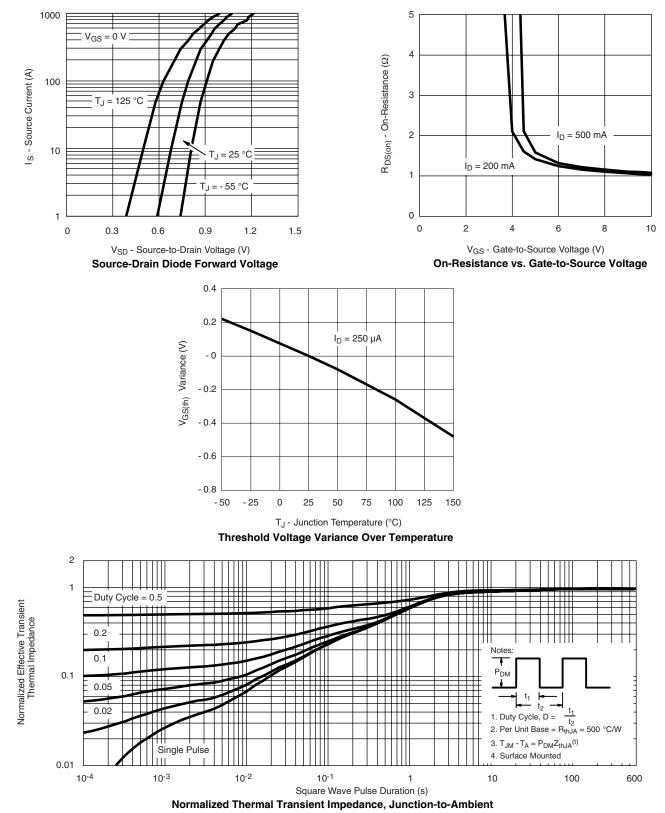
100

Si1026X

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71434.



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